Bourns Manufacturers Representatives
Corporate Distributor Product Managers
Americas Sales Team
Asia Sales Team
Europe Sales Team

Bourns® ESD & EMI Filter Products
End of Life

Riverside, California - August 13, 2007 - Bourns Inc. has promoted and supported ESD & EMI filter products to the portable electronics market for over 10 years. During the past 2 years, there has been a distinct technology trend in component packaging towards wire bond plastic mold packaging and away from wafer level Chip Scale Packaging for manufacturing reasons.

With a current lack of any mass production orders or sample orders for the ESD & EMI filters using Chip Scale Packaging, Bourns will cease to support these products immediately. The affected 26 part numbers are as follows:

- 2DAA-F6R 2DAA-F6RLF
- 2DAB-F6R 2DAB-F6RLF
- 2DAC-C16R 2DAC-C16RLF
- 2DAD-C5R 2DAD-C5RLF
- 2FAD-C20R 2FAD-C20RLF
- 2FAE-C15R 2FAE-C15RLF
- 2FAF-C10R 2FAF-C10RLF
- 2FAG-C15R 2FAG-C15RLF
- 2FAH-C20R 2FAH-C20RLF
- 2FAK-C15R 2FAK-C15RLF
- 2FAM-C5R 2FAM-C5RLF
- 2FAN-C5R 2FAM-C5RLF

It is not envisaged that this will cause any negative perception issues in the field as little or no business exists for these part numbers and there is minimal excess or exposed inventory.